

Innovative 3D training platform for Recycling of Waste Electric and Electronic Devices

Application n°:	540527-LLP-1-2013-1-GR-LEONARDO-LMP
Project acronym:	RECDEV

4th Skype Meeting - 16/12/2014, 12:00 Gr. Time

AGENDA

1. Legal - Aspects

- Partner Change: STENUM – BAN
- After approval of BAN as a new partner, we will have to make Amendment No2 in the Consortium Agreement (CA) – we will send the Document for signatures by the Legal Representatives
- Any other topic raised by the partners

2. Mid-Term Reporting

- When - How
- Usual activities as we did in the 1st Stress Test
- Any other topic raised by the partners



3. Work Packages Development – Presentation from all partners of completed and planned activities

- WP1 Project Management (ARVIS)
- WP2 Quality Assurance (ARVIS – STENUM/BAN)
- WP3 Development of the training methodology and scenarios (ARVIS)
- WP4 Development and setup of the virtual environments (ARVIS- OMEGATECH)
- WP6 Dissemination (NCSPC-HSWMA)

- Any other topic raised by the partners

4. Past and Upcoming Dissemination Events and Meetings

- Lyon, France 17th EcoInnovation Forum
- Graz, Austria Workshop and Steering Committee (Late in March 2015)
- CEMEPE 2015 – Mykonos Island, Greece
- Brno, Czech Republic - October/November 2015

5. Next Skype meeting

6. Any other Business (AOB)

Time schedule: ~ 0.45 hours

